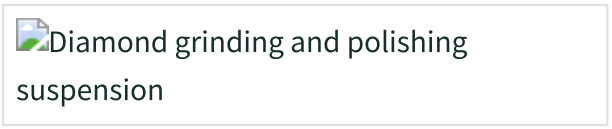
Diamond grinding and polishing suspension

Diamond grinding and polishing suspension • Technical datasheet

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The suspension is intended to support grinding and material removal while reducing surface scratches. Its principal characteristics are abrasive removal performance and suspension stability.

Specifications

Grit 0.1um, 0.25um	
Capacity 500m	
Composition diamond micropowder	

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Compiled from published product information. Final configuration follows the technical agreement; confirm options, fixtures and scope with an application engineer.

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